

Terms and Conditions governing submissions to the Texas Instruments Innovation Challenge: India Analog Design Contest 2014

Please read and accept the following terms and conditions prior to making any submissions or providing any ideas or materials to Texas Instruments (India) Private Limited ("TI") in respect of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014. All submissions made for the contest are subject to these terms and conditions and by making the submission, you would be deemed to have unconditionally acknowledged and accepted the same:

1. The evaluation, use and publication of materials, designs and/or ideas submitted by participants in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 is the sole prerogative of the TI management. The manner, mode, form and timing of evaluation, use or publication, as also the alteration, deletion, addition and editing of content of the materials, designs or ideas submitted to TI as part of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 shall be determined by TI's management at its sole discretion. No causes shall be required to be furnished by TI to any participant in respect of the acceptance, rejection, and alteration or editing of any materials, designs or ideas submitted by such participant. TI reserves the right to withhold the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 results from you and/or all or any of the participants without specifying any reasons in that regard.
2. By making a submission as part of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014, you expressly agree to irrevocably, perpetually and exclusively grant and assign in favour of Texas Instruments (India) Private Limited (TI), without any geographical restriction and on a royalty free basis, all rights, title and interest, including but not limited to patents, designs, mask-works, copyright and rights of reproduction, re-use and moral rights, in respect of the materials, designs and/or ideas submitted by you to TI. Upon submission to TI, you shall cease to enjoy or retain any right, title or interest over the material, design or idea in question. You agree to duly sign and execute all documents as may be needed by TI to give effect to the above grant/assignment. The fact that such materials, designs and/or ideas could potentially make you eligible for awards offered by TI to a winning participant of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 forms sufficient consideration for the above grant and assignment, irrespective of whether or not you are finally selected as the winner of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 or provided any award or recognition by TI.
3. All materials, designs and ideas submitted by you to TI must be bona-fide original works attributable to yourself and must not in any manner infringe any third party intellectual property rights or incorporate the intellectual property of a third party (except as expressly authorized by such third party and notified by you to TI in writing along with the submission). Finally, no proprietary, confidential or sensitive materials belonging to a third party should be submitted to TI and TI is not in a position to assure confidentiality in respect of the submission. In the event of any non-

compliance with the foregoing, you hereby agree to indemnify and keep indemnified TI and its group companies and their directors, officers and employees against all losses, claims, damages, liabilities and expenses (including attorney fees) incurred by TI and its group companies and their directors, officers and employees consequent to such non-compliance.

4. You shall ensure that you comply with all applicable laws and the policies and procedures of your employer/educational institution in making the submissions for the Texas Instruments Innovation Challenge: India Analog Design Contest 2014. TI has no duty to check your submissions for such compliance and you alone shall be responsible for all consequences of failing to adhere to the pertinent laws, policies or procedures.
5. Nothing in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 or in any subsequent interview or interaction with TI personnel shall be construed as creating any obligations upon TI vis-à-vis you or any third parties. Without prejudice to the foregoing, allowing you to participate in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and any subsequent interview or interaction shall not be deemed an offer of employment with TI.
6. TI makes no warranties whatsoever, whether express or implied, in respect of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and any subsequent interview or interaction and hereby disclaims all liability to you and all other participants in respect of acts or omissions regarding the conduct of the same and any decisions made by TI with respect to selection of winning entries or use of submitted materials, designs or ideas. TI shall not accept any liability in respect of any errors or oversights in conducting the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and selecting winning participants.
7. You shall not indulge in any unfair or unethical means in order to improve your chances of winning the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and if you are found doing so, you shall be liable, without prejudice to any other rights or remedies enjoyed by TI, to be summarily removed from participating further in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 without any explanations being entertained. You must refrain from sharing the details of your Texas Instruments Innovation Challenge: India Analog Design Contest 2014 submissions or TI's responses in that behalf with any other participants or persons except as specifically permitted by TI.
8. You shall abide by all Texas Instruments Innovation Challenge: India Analog Design Contest 2014 related rules and guidelines as may be communicated to you by TI's representatives and shall not question the same. TI expressly reserves the right to modify the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 related rules, guidelines and awards as well as these terms and conditions at any time without being required to notify or seek consent from you or any other participants.

9. TI is not liable to reimburse any expenses that may have been incurred by you with a view to participating in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and shall not accept any claims in that regard.
10. All awards and payments made by TI in respect of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 shall be subjected to tax and other statutory deductions at source as mandated by law. Any and all taxes, surcharges, cesses and charges in respect of the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 awards shall be borne by the winners alone and TI shall not be liable for the same.
11. TI's decision in respect of any matter concerning the Texas Instruments Innovation Challenge: India Analog Design Contest 2014 and any subsequent interview or interaction shall be final and binding upon you and you shall accept the same without demur. In any event, all disputes amongst TI and you or any third parties claiming through you shall be subject to the sole jurisdiction of the courts at Bangalore, India.

In the event that any of the above terms are unacceptable to you, please refrain from participating in the Texas Instruments Innovation Challenge: India Analog Design Contest 2014.

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TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

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